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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

| Details | |
|--------------------------------|---|
| Product Status | Discontinued at Digi-Key |
| Number of LABs/CLBs | 250540 |
| Number of Logic Elements/Cells | 660000 |
| Total RAM Bits | 49610752 |
| Number of I/O | 396 |
| Number of Gates | - |
| Voltage - Supply | 0.87V ~ 0.98V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 1152-BBGA, FCBGA |
| Supplier Device Package | 1152-FCBGA (35x35) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/10ax066k2f35i2sges |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



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Key Advantages of Intel Arria 10 Devices

Table 2. Key Advantages of the Intel Arria 10 Device Family

| Advantage | Supporting Feature |
|---|---|
| Enhanced core architecture | Built on TSMC's 20 nm process technology 60% higher performance than the previous generation of mid-range FPGAs 15% higher performance than the fastest previous-generation FPGA |
| High-bandwidth integrated transceivers | Short-reach rates up to 25.8 Gigabits per second (Gbps) Backplane capability up to 12.5 Gbps Integrated 10GBASE-KR and 40GBASE-KR4 Forward Error Correction (FEC) |
| Improved logic integration and hard IP blocks | 8-input adaptive logic module (ALM) Up to 65.6 megabits (Mb) of embedded memory Variable-precision digital signal processing (DSP) blocks Fractional synthesis phase-locked loops (PLLs) Hard PCI Express Gen3 IP blocks Hard memory controllers and PHY up to 2,400 Megabits per second (Mbps) |
| Second generation hard processor system (HPS) with integrated ARM* Cortex*-A9* MPCore* processor | Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Intel Arria 10 system-on-a-chip (SoC) Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric |
| Advanced power savings | Comprehensive set of advanced power saving features Power-optimized MultiTrack routing and core architecture Up to 40% lower power compared to previous generation of mid-range FPGAs Up to 60% lower power compared to previous generation of high-end FPGAs |

Summary of Intel Arria 10 Features

Table 3. Summary of Features for Intel Arria 10 Devices

| Feature | Description |
|---------------------------------|---|
| Technology | TSMC's 20-nm SoC process technology Allows operation at a lower V_{CC} level of 0.82 V instead of the 0.9 V standard V_{CC} core voltage |
| Packaging | 1.0 mm ball-pitch Fineline BGA packaging 0.8 mm ball-pitch Ultra Fineline BGA packaging Multiple devices with identical package footprints for seamless migration between different FPGA densities Devices with compatible package footprints allow migration to next generation high-end Stratix® 10 devices RoHS, leaded⁽¹⁾, and lead-free (Pb-free) options |
| High-performance FPGA fabric | Enhanced 8-input ALM with four registers Improved multi-track routing architecture to reduce congestion and improve compilation time Hierarchical core clocking architecture Fine-grained partial reconfiguration |
| Internal memory blocks | M20K—20-Kb memory blocks with hard error correction code (ECC) Memory logic array block (MLAB)—640-bit memory |
| | continued |

⁽¹⁾ Contact Intel for availability.

A10-OVERVIEW | 2018.04.09



| Feature | | Description | | | | | |
|--------------------------------------|--|--|--|--|--|--|--|
| Embedded Hard IP blocks | Variable-precision DSP | Native support for signal processing precision levels from 18 x 19 to 54 x 54 Native support for 27 x 27 multiplier mode 64-bit accumulator and cascade for systolic finite impulse responses (FIRs) Internal coefficient memory banks Preadder/subtractor for improved efficiency Additional pipeline register to increase performance and reduce power Supports floating point arithmetic: Perform multiplication, addition, subtraction, multiply-add, multiply-subtract, and complex multiplication. Supports multiplication with accumulation capability, cascade summation, and cascade subtraction capability. Dynamic accumulator reset control. Support direct vector dot and complex multiplication chaining multiply floating point DSP blocks. | | | | | |
| | Memory controller | DDR4, DDR3, and DDR3L | | | | | |
| | PCI Express* | PCI Express (PCIe*) Gen3 (x1, x2, x4, or x8), Gen2 (x1, x2, x4, or x8) and Gen1 (x1, x2, x4, or x8) hard IP with complete protocol stack, endpoint, and root port | | | | | |
| | Transceiver I/O | 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC) PCS hard IPs that support: | | | | | |
| Core clock networks | 667 MHz externa 800 MHz LVDS in Global, regional, and | c clocking, depending on the application: I memory interface clocking with 2,400 Mbps DDR4 interface terface clocking with 1,600 Mbps LVDS interface I peripheral clock networks are not used can be gated to reduce dynamic power | | | | | |
| Phase-locked loops (PLLs) | High-resolution fractional synthesis PLLs: — Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) — Support integer mode and fractional mode — Fractional mode support with third-order delta-sigma modulation Integer PLLs: — Adjacent to general purpose I/Os — Support external memory and LVDS interfaces | | | | | | |
| FPGA General-purpose I/Os (GPIOs) | 1.6 Gbps LVDS—every pair can be configured as receiver or transmitter On-chip termination (OCT) 1.2 V to 3.0 V single-ended LVTTL/LVCMOS interfacing | | | | | | |
| External Memory Interface | Hard memory controller— DDR4, DDR3, and DDR3L support DDR4—speeds up to 1,200 MHz/2,400 Mbps DDR3—speeds up to 1,067 MHz/2,133 Mbps Soft memory controller—provides support for RLDRAM 3 ⁽²⁾ , QDR IV ⁽²⁾ , and QDR II+ continued. | | | | | | |



Maximum Resources

Table 5. Maximum Resource Counts for Intel Arria 10 GX Devices (GX 160, GX 220, GX 270, GX 320, and GX 480)

| Resc | ource | | | Product Line | | | |
|------------------------------|-------------------------|---------|---------|---------------------|---------|---------|--|
| | | GX 160 | GX 220 | GX 270 | GX 320 | GX 480 | |
| Logic Elements | (LE) (K) | 160 | 220 | 270 | 320 | 480 | |
| ALM | | 61,510 | 80,330 | 101,620 | 119,900 | 183,590 | |
| Register | | 246,040 | 321,320 | 406,480 | 479,600 | 734,360 | |
| Memory (Kb) | M20K | 8,800 | 11,740 | 15,000 | 17,820 | 28,620 | |
| | MLAB | 1,050 | 1,690 | 2,452 | 2,727 | 4,164 | |
| Variable-precision DSP Block | | 156 | 192 | 830 | 985 | 1,368 | |
| 18 x 19 Multipli | er | 312 | 384 | 1,660 | 1,970 | 2,736 | |
| PLL | Fractional Synthesis | 6 | 6 | 8 | 8 | 12 | |
| | I/O | 6 | 6 | 8 | 8 | 12 | |
| 17.4 Gbps Trans | sceiver | 12 | 12 | 24 | 24 | 36 | |
| GPIO (3) | | 288 | 288 | 384 | 384 | 492 | |
| LVDS Pair (4) | | 120 | 120 | 168 | 168 | 222 | |
| PCIe Hard IP Bl | ock | 1 | 1 2 | | 2 | 2 | |
| Hard Memory C | ontroller | 6 | 6 | 8 | 8 | 12 | |

 $^{^{(3)}}$ The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

⁽⁴⁾ Each LVDS I/O pair can be used as differential input or output.



Table 8. Package Plan for Intel Arria 10 GX Devices (F34, F35, NF40, and KF40)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F34 (35 mm × 35 mm, 1152-pin FBGA) | | | | F35 (35 mm × 35 mm, 1152-pin FBGA) | | | KF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF40 (40 mm × 40 mm, 1517-pin FBGA) | | |
|--------------|--|-------------|------|------------|--|------|------------|---|------|------------|---|------|--|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | |
| GX 270 | 48 | 336 | 24 | 48 | 336 | 24 | _ | _ | _ | _ | _ | _ | |
| GX 320 | 48 | 336 | 24 | 48 | 336 | 24 | _ | _ | _ | _ | _ | _ | |
| GX 480 | 48 | 444 | 24 | 48 | 348 | 36 | _ | _ | _ | _ | _ | - | |
| GX 570 | 48 | 444 | 24 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 | |
| GX 660 | 48 | 444 | 24 | 48 | 348 | 36 | 96 | 600 | 36 | 48 | 540 | 48 | |
| GX 900 | _ | 504 | 24 | _ | _ | _ | _ | _ | _ | _ | 600 | 48 | |
| GX 1150 | _ | 504 | 24 | _ | _ | _ | _ | _ | _ | _ | 600 | 48 | |

Table 9. Package Plan for Intel Arria 10 GX Devices (RF40, NF45, SF45, and UF45)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | RF40 (40 mm × 40 mm, 1517-pin FBGA) | | | NF45 (45 mm × 45 mm) 1932-pin FBGA) | | | SF45 (45 mm × 45 mm) 1932-pin FBGA) | | | UF45 (45 mm × 45 mm) 1932-pin FBGA) | | |
|--------------|---|-------------|------|---|-------------|------|---|-------------|------|---|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR |
| GX 900 | _ | 342 | 66 | _ | 768 | 48 | - | 624 | 72 | _ | 480 | 96 |
| GX 1150 | _ | 342 | 66 | _ | 768 | 48 | ı | 624 | 72 | ı | 480 | 96 |

Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

Intel Arria 10 GT

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GT devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.



Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

Intel Arria 10 SX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.

Available Options

Figure 3. Sample Ordering Code and Available Options for Intel Arria 10 SX Devices



Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



Maximum Resources

Table 12. Maximum Resource Counts for Intel Arria 10 SX Devices

| Reso | ource | | | I | Product Line | | | |
|-----------------------------------|-------------------------|---------|---------|---------|--------------|---------|---------|-----------|
| | | SX 160 | SX 220 | SX 270 | SX 320 | SX 480 | SX 570 | SX 660 |
| Logic Elements | s (LE) (K) | 160 | 220 | 270 | 320 | 480 | 570 | 660 |
| ALM | | 61,510 | 80,330 | 101,620 | 119,900 | 183,590 | 217,080 | 251,680 |
| Register | | 246,040 | 321,320 | 406,480 | 479,600 | 734,360 | 868,320 | 1,006,720 |
| Memory (Kb) | M20K | 8,800 | 11,740 | 15,000 | 17,820 | 28,620 | 36,000 | 42,620 |
| | MLAB | 1,050 | 1,690 | 2,452 | 2,727 | 4,164 | 5,096 | 5,788 |
| Variable-precision DSP Block | | 156 | 192 | 830 | 985 | 1,368 | 1,523 | 1,687 |
| 18 x 19 Multip | lier | 312 | 384 | 1,660 | 1,970 | 2,736 | 3,046 | 3,374 |
| PLL | Fractional Synthesis | 6 | 6 | 8 | 8 | 12 | 16 | 16 |
| | I/O | 6 | 6 | 8 | 8 | 12 | 16 | 16 |
| 17.4 Gbps Tra | nsceiver | 12 | 12 | 24 | 24 | 36 | 48 | 48 |
| GPIO (8) | | 288 | 288 | 384 | 384 | 492 | 696 | 696 |
| LVDS Pair (9) | | 120 | 120 | 168 | 168 | 174 | 324 | 324 |
| PCIe Hard IP E | Block | 1 | 1 | 2 | 2 | 2 | 2 | 2 |
| Hard Memory | Controller | 6 | 6 | 8 | 8 | 12 | 16 | 16 |
| ARM Cortex-A9 MPCore Processor | | Yes | Yes | Yes | Yes | Yes | Yes | Yes |

Package Plan

Table 13. Package Plan for Intel Arria 10 SX Devices (U19, F27, F29, and F34)

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | U19 (19 mm × 19 mm, 484-pin UBGA) | | | F27 (27 mm × 27 mm, 672-pin FBGA) | | | F29 (29 mm × 29 mm, 780-pin FBGA) | | | F34 (35 mm × 35 mm, 1152-pin FBGA) | | |
|--------------|---|-------------|------|---|-------------|------|---|-------------|------|--|-------------|------|
| | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR | 3 V I/O | LVDS I/O | XCVR |
| SX 160 | 48 | 144 | 6 | 48 | 192 | 12 | 48 | 240 | 12 | _ | _ | _ |
| SX 220 | 48 | 144 | 6 | 48 | 192 | 12 | 48 | 240 | 12 | _ | _ | _ |
| SX 270 | _ | _ | _ | 48 | 192 | 12 | 48 | 312 | 12 | 48 | 336 | 24 |
| SX 320 | _ | _ | _ | 48 | 192 | 12 | 48 | 312 | 12 | 48 | 336 | 24 |
| | | | | | | | | | | | contii | nued |

 $^{^{(8)}}$ The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

⁽⁹⁾ Each LVDS I/O pair can be used as differential input or output.



I/O Vertical Migration for Intel Arria 10 Devices

Figure 4. Migration Capability Across Intel Arria 10 Product Lines

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use
 memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to
 banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

| Variant | Product | | | | | | Package | e | | | | |
|---------------------|---------|----------|----------|----------|----------|----------|----------|----------|------|------|----------|----------|
| Varialit | Line | U19 | F27 | F29 | F34 | F35 | KF40 | NF40 | RF40 | NF45 | SF45 | UF45 |
| | GX 160 | 1 | 1 | 1 | | | | | | | | |
| | GX 220 | + | | | | | | | | | | |
| | GX 270 | | | | 1 | 1 | | | | | | |
| | GX 320 | | V | | | | | | | | | |
| Intel® Arria® 10 GX | GX 480 | | | V | | | | | | | | |
| | GX 570 | | | | | | 1 | 1 | | | | |
| | GX 660 | | | | | V | \ | | | | | |
| | GX 900 | | | | | | | | 1 | 1 | | 1 |
| | GX 1150 | | | | V | | | + | + | + | | + |
| Intel Arria 10 GT | GT 900 | | | | | | | | | | | |
| intel Afria 10 G1 | GT 1150 | | | | | | | | | | V | |
| | SX 160 | 1 | 1 | 1 | | | | | | | | |
| | SX 220 | + | | | | | | | | | | |
| | SX 270 | | | | 1 | † | | | | | | |
| Intel Arria 10 SX | SX 320 | | V | | | | | | | | | |
| | SX 480 | | | V | | | | | | | | |
| | SX 570 | | | | | | † | † | | | | |
| | SX 660 | | | | * | | | | | | | |

Note:

To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

Adaptive Logic Module

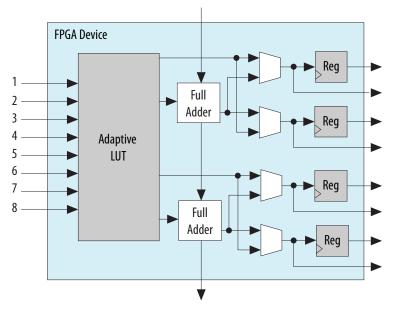
Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.



Figure 5. ALM for Intel Arria 10 Devices



The Intel Quartus Prime software optimizes your design according to the ALM logic structure and automatically maps legacy designs into the Intel Arria 10 ALM architecture.

Variable-Precision DSP Block

The Intel Arria 10 variable precision DSP blocks support fixed-point arithmetic and floating-point arithmetic.

Features for fixed-point arithmetic:

- · High-performance, power-optimized, and fully registered multiplication operations
- 18-bit and 27-bit word lengths
- Two 18 x 19 multipliers or one 27 x 27 multiplier per DSP block
- Built-in addition, subtraction, and 64-bit double accumulation register to combine multiplication results
- Cascading 19-bit or 27-bit when pre-adder is disabled and cascading 18-bit when pre-adder is used to form the tap-delay line for filtering applications
- Cascading 64-bit output bus to propagate output results from one block to the next block without external logic support
- Hard pre-adder supported in 19-bit and 27-bit modes for symmetric filters
- Internal coefficient register bank in both 18-bit and 27-bit modes for filter implementation
- 18-bit and 27-bit systolic finite impulse response (FIR) filters with distributed output adder
- Biased rounding support



| Variant | Product Line | Variable- precision | Independent In Multiplication | | 18 x 19 Multiplier | 18 x 18 Multiplier Adder |
|---------|--------------|------------------------|----------------------------------|-----------------------|-----------------------|--------------------------------|
| | | DSP Block | 18 x 19 Multiplier | 27 x 27 Multiplier | Adder Sum Mode | Summed with 36 bit Input |
| | SX 320 | 984 | 1,968 | 984 | 984 | 984 |
| | SX 480 | 1,368 | 2,736 | 1,368 | 1,368 | 1,368 |
| | SX 570 | 1,523 | 3,046 | 1,523 | 1,523 | 1,523 |
| | SX 660 | 1,687 | 3,374 | 1,687 | 1,687 | 1,687 |

Table 17. Resources for Floating-Point Arithmetic in Intel Arria 10 Devices

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant | Product Line | Variable- precision DSP Block | Single Precision Floating-Point Multiplication Mode | Single-Precision Floating-Point Adder Mode | Single- Precision Floating-Point Multiply Accumulate Mode | Peak Giga Floating- Point Operations per Second (GFLOPs) |
|----------------|--------------|-------------------------------------|---|--|--|--|
| Intel Arria 10 | GX 160 | 156 | 156 | 156 | 156 | 140 |
| GX | GX 220 | 192 | 192 | 192 | 192 | 173 |
| | GX 270 | 830 | 830 | 830 | 830 | 747 |
| | GX 320 | 984 | 984 | 984 | 984 | 886 |
| | GX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | GX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | GX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |
| | GX 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| | GX 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | GT 900 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| GT | GT 1150 | 1,518 | 1,518 | 1,518 | 1,518 | 1,366 |
| Intel Arria 10 | SX 160 | 156 | 156 | 156 | 156 | 140 |
| SX | SX 220 | 192 | 192 | 192 | 192 | 173 |
| | SX 270 | 830 | 830 | 830 | 830 | 747 |
| | SX 320 | 984 | 984 | 984 | 984 | 886 |
| | SX 480 | 1,369 | 1,368 | 1,368 | 1,368 | 1,231 |
| | SX 570 | 1,523 | 1,523 | 1,523 | 1,523 | 1,371 |
| | SX 660 | 1,687 | 1,687 | 1,687 | 1,687 | 1,518 |

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

Embedded Memory Capacity in Intel Arria 10 Devices

Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices

| | Product | M2 | 20K | ML | .AB | Total RAM Bit |
|-------------------|---------|-------|--------------|--------|--------------|---------------|
| Variant | Line | Block | RAM Bit (Kb) | Block | RAM Bit (Kb) | (Kb) |
| Intel Arria 10 GX | GX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | GX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | GX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | GX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | GX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | GX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | GX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |
| | GX 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GX 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 GT | GT 900 | 2,423 | 48,460 | 15,017 | 9,386 | 57,846 |
| | GT 1150 | 2,713 | 54,260 | 20,774 | 12,984 | 67,244 |
| Intel Arria 10 SX | SX 160 | 440 | 8,800 | 1,680 | 1,050 | 9,850 |
| | SX 220 | 587 | 11,740 | 2,703 | 1,690 | 13,430 |
| | SX 270 | 750 | 15,000 | 3,922 | 2,452 | 17,452 |
| | SX 320 | 891 | 17,820 | 4,363 | 2,727 | 20,547 |
| | SX 480 | 1,431 | 28,620 | 6,662 | 4,164 | 32,784 |
| | SX 570 | 1,800 | 36,000 | 8,153 | 5,096 | 41,096 |
| | SX 660 | 2,131 | 42,620 | 9,260 | 5,788 | 48,408 |



Embedded Memory Configurations for Single-port Mode

Table 19. Single-port Embedded Memory Configurations for Intel Arria 10 Devices

This table lists the maximum configurations supported for single-port RAM and ROM modes.

| Memory Block | Depth (bits) | Programmable Width |
|--------------|--------------|--------------------|
| MLAB | 32 | x16, x18, or x20 |
| | 64 (10) | x8, x9, x10 |
| M20K | 512 | x40, x32 |
| | 1K | x20, x16 |
| | 2K | x10, x8 |
| | 4K | x5, x4 |
| | 8K | x2 |
| | 16K | x1 |

Clock Networks and PLL Clock Sources

The clock network architecture is based on Intel's global, regional, and peripheral clock structure. This clock structure is supported by dedicated clock input pins, fractional clock synthesis PLLs, and integer I/O PLLs.

Clock Networks

The Intel Arria 10 core clock networks are capable of up to 800 MHz fabric operation across the full industrial temperature range. For the external memory interface, the clock network supports the hard memory controller with speeds up to 2,400 Mbps in a quarter-rate transfer.

To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.

Fractional Synthesis and I/O PLLs

Intel Arria 10 devices contain up to 32 fractional synthesis PLLs and up to 16 I/O PLLs that are available for both specific and general purpose uses in the core:

- Fractional synthesis PLLs—located in the column adjacent to the transceiver blocks
- I/O PLLs-located in each bank of the 48 I/Os

Fractional Synthesis PLLs

You can use the fractional synthesis PLLs to:

- Reduce the number of oscillators that are required on your board
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

⁽¹⁰⁾ Supported through software emulation and consumes additional MLAB blocks.

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The fractional synthesis PLLs support the following features:

- Reference clock frequency synthesis for transceiver CMU and Advanced Transmit (ATX) PLLs
- Clock network delay compensation
- Zero-delay buffering
- Direct transmit clocking for transceivers
- Independently configurable into two modes:
 - Conventional integer mode equivalent to the general purpose PLL
 - Enhanced fractional mode with third order delta-sigma modulation
- PLL cascading

I/O PLLs

The integer mode I/O PLLs are located in each bank of 48 I/Os. You can use the I/O PLLs to simplify the design of external memory and high-speed LVDS interfaces.

In each I/O bank, the I/O PLLs are adjacent to the hard memory controllers and LVDS SERDES. Because these PLLs are tightly coupled with the I/Os that need to use them, it makes it easier to close timing.

You can use the I/O PLLs for general purpose applications in the core such as clock network delay compensation and zero-delay buffering.

Intel Arria 10 devices support PLL-to-PLL cascading.

FPGA General Purpose I/O

Intel Arria 10 devices offer highly configurable GPIOs. Each I/O bank contains 48 general purpose I/Os and a high-efficiency hard memory controller.

The following list describes the features of the GPIOs:

- Consist of 3 V I/Os for high-voltage application and LVDS I/Os for differential signaling
 - $-\$ Up to two 3 V I/O banks, available in some devices, that support up to 3 V I/O standards
 - LVDS I/O banks that support up to 1.8 V I/O standards
- Support a wide range of single-ended and differential I/O interfaces
- LVDS speeds up to 1.6 Gbps
- Each LVDS pair of pins has differential input and output buffers, allowing you to configure the LVDS direction for each pair.
- Programmable bus hold and weak pull-up
- Programmable differential output voltage (V_{OD}) and programmable pre-emphasis



Table 20. Memory Standards Supported by the Hard Memory Controller

This table lists the overall capability of the hard memory controller. For specific details, refer to the External Memory Interface Spec Estimator and Intel Arria 10 Device Datasheet.

| Memory Standard | Rate Support | Ping Pong PHY Support | Maximum Frequency (MHz) |
|-----------------|--------------|-----------------------|-------------------------|
| DDR4 SDRAM | Quarter rate | Yes | 1,067 |
| | | _ | 1,200 |
| DDR3 SDRAM | Half rate | Yes | 533 |
| | | _ | 667 |
| | Quarter rate | Yes | 1,067 |
| | | _ | 1,067 |
| DDR3L SDRAM | Half rate | Yes | 533 |
| | | _ | 667 |
| | Quarter rate | Yes | 933 |
| | | _ | 933 |
| LPDDR3 SDRAM | Half rate | _ | 533 |
| | Quarter rate | _ | 800 |

Table 21. Memory Standards Supported by the Soft Memory Controller

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------------------|--------------|----------------------------|
| RLDRAM 3 (11) | Quarter rate | 1,200 |
| QDR IV SRAM ⁽¹¹⁾ | Quarter rate | 1,067 |
| QDR II SRAM | Full rate | 333 |
| | Half rate | 633 |
| QDR II+ SRAM | Full rate | 333 |
| | Half rate | 633 |
| QDR II+ Xtreme SRAM | Full rate | 333 |
| | Half rate | 633 |

Table 22. Memory Standards Supported by the HPS Hard Memory Controller

The hard processor system (HPS) is available in Intel Arria 10 SoC devices only.

| Memory Standard | Rate Support | Maximum Frequency (MHz) |
|-----------------|--------------|----------------------------|
| DDR4 SDRAM | Half rate | 1,200 |
| DDR3 SDRAM | Half rate | 1,067 |
| DDR3L SDRAM | Half rate | 933 |

⁽¹¹⁾ Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices

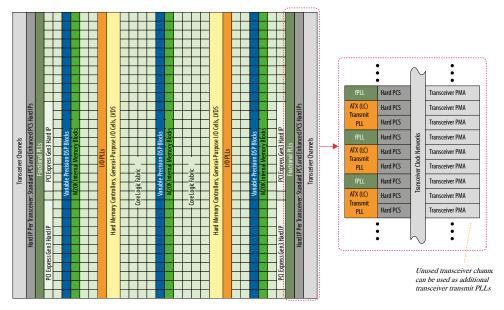
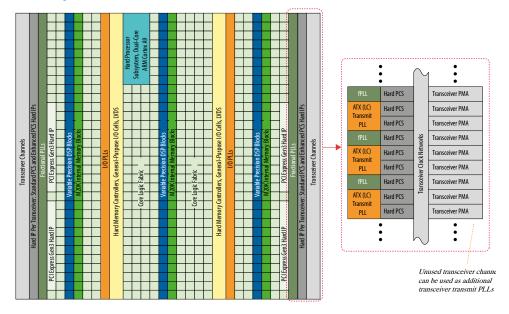


Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



PMA Features

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



Table 24. **Improvements in 20 nm HPS**

This table lists the key improvements of the 20 nm HPS compared to the 28 nm HPS.

| Advantages/ Improvements | Description |
|---|--|
| Increased performance and overdrive capability | While the nominal processor frequency is 1.2 GHz, the 20 nm HPS offers an "overdrive" feature which enables a higher processor operating frequency. This requires a higher supply voltage value that is unique to the HPS and may require a separate regulator. |
| Increased processor memory bandwidth and DDR4 support | Up to 64-bit DDR4 memory at 2,400 Mbps support is available for the processor. The hard memory controller for the HPS comprises a multi-port front end that manages connections to a single port memory controller. The multi-port front end allows logic core and the HPS to share ports and thereby the available bandwidth of the memory controller. |
| Flexible I/O sharing | An advanced I/O pin muxing scheme allows improved sharing of I/O between the HPS and the core logic. The following types of I/O are available for SoC: 17 dedicated I/Os—physically located inside the HPS block and are not accessible to logic within the core. The 17 dedicated I/Os are used for HPS clock, resets, and interfacing with boot devices, QSPI, and SD/MMC. 48 direct shared I/O—located closest to the HPS block and are ideal for high speed HPS peripherals such as EMAC, USB, and others. There is one bank of 48 I/Os that supports direct sharing where the 48 I/Os can be shared 12 I/Os at a time. Standard (shared) I/O—all standard I/Os can be shared by the PPS peripherals and any logic within the core. For designs where more than 48 I/Os are required to fully use all the peripherals in the HPS, these I/Os can be connected through the core logic. |
| EMAC core | Three EMAC cores are available in the HPS. The EMAC cores enable an application to support two redundant Ethernet connections; for example, backplane, or two EMAC cores for managing IEEE 1588 time stamp information while allowing a third EMAC core for debug and configuration. All three EMACs can potentially share the same time stamps, simplifying the 1588 time stamping implementation. A new serial time stamp interface allows core logic to access and read the time stamp values. The integrated EMAC controllers can be connected to external Ethernet PHY through the provided MDIO or I ² C interface. |
| On-chip memory | The on-chip memory is updated to 256 KB support and can support larger data sets and real time algorithms. |
| ECC enhancements | Improvements in L2 Cache ECC management allow identification of errors down to the address level. ECC enhancements also enable improved error injection and status reporting via the introduction of new memory mapped access to syndrome and data signals. |
| HPS to FPGA Interconnect Backbone | Although the HPS and the Logic Core can operate independently, they are tightly coupled via a high-bandwidth system interconnect built from high-performance ARM AMBA AXI bus bridges. IP bus masters in the FPGA fabric have access to HPS bus slaves via the FPGA-to-HPS interconnect. Similarly, HPS bus masters have access to bus slaves in the core fabric via the HPS-to-FPGA bridge. Both bridges are AMBA AXI-3 compliant and support simultaneous read and write transactions. Up to three masters within the core fabric can share the HPS SDRAM controller with the processor. Additionally, the processor can be used to configure the core fabric under program control via a dedicated 32-bit configuration port. |
| FPGA configuration and HPS booting | The FPGA fabric and HPS in the SoCs are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power. You can configure the FPGA fabric and boot the HPS independently, in any order, providing you with more design flexibility. |
| Security | New security features have been introduced for anti-tamper management, secure boot, encryption (AES), and authentication (SHA). |



| Scheme | Data Width | Max Clock Rate (MHz) | Max Data Rate (Mbps) | Decompression | Design Security ⁽¹ 4) | Partial Reconfiguration (15) | Remote System Update |
|--|----------------------------|----------------------------|----------------------------|---------------|--|------------------------------------|----------------------------|
| Fast passive | 8 bits | 100 | 3200 | Yes | Yes | Yes ⁽¹⁷⁾ | PFL IP |
| parallel (FPP) through CPLD or | 16 bits | | | Yes | Yes | 1 | core |
| external microcontroller | 32 bits | | | Yes | Yes | | |
| Configuration via | 16 bits | 100 | 3200 | Yes | Yes | Yes ⁽¹⁷⁾ | _ |
| HPS | 32 bits | | | Yes | Yes | | |
| Configuration via Protocol [CvP (PCIe*)] | x1, x2, x4, x8 lanes | _ | 8000 | Yes | Yes | Yes ⁽¹⁶⁾ | _ |

You can configure Intel Arria 10 devices through PCIe using Configuration via Protocol (CvP). The Intel Arria 10 CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

SEU Error Detection and Correction

Intel Arria 10 devices offer robust and easy-to-use single-event upset (SEU) error detection and correction circuitry.

The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running CRC error detection circuit with integrated ECC that automatically corrects one or two errors and detects higher order multi-bit errors. When more than two errors occur, correction is available through reloading of the core programming file, providing a complete design refresh while the FPGA continues to operate.

The physical layout of the Intel Arria 10 CRAM array is optimized to make the majority of multi-bit upsets appear as independent single-bit or double-bit errors which are automatically corrected by the integrated CRAM ECC circuitry. In addition to the CRAM protection, the M20K memory blocks also include integrated ECC circuitry and are layout-optimized for error detection and correction. The MLAB does not have ECC.

Power Management

Intel Arria 10 devices leverage the advanced 20 nm process technology, a low 0.9 V core power supply, an enhanced core architecture, and several optional power reduction techniques to reduce total power consumption by as much as 40% compared to Arria V devices and as much as 60% compared to Stratix V devices.

⁽¹³⁾ Enabling either compression or design security features affects the maximum data rate. Refer to the Intel Arria 10 Device Datasheet for more information.

⁽¹⁴⁾ Encryption and compression cannot be used simultaneously.

⁽¹⁵⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Intel for support.

⁽¹⁷⁾ Supported at a maximum clock rate of 100 MHz.



The optional power reduction techniques in Intel Arria 10 devices include:

- SmartVID—a code is programmed into each device during manufacturing that allows a smart regulator to operate the device at lower core V_{CC} while maintaining performance
- **Programmable Power Technology**—non-critical timing paths are identified by the Intel Quartus Prime software and the logic in these paths is biased for low power instead of high performance
- **Low Static Power Options**—devices are available with either standard static power or low static power while maintaining performance

Furthermore, Intel Arria 10 devices feature Intel's industry-leading low power transceivers and include a number of hard IP blocks that not only reduce logic resources but also deliver substantial power savings compared to soft implementations. In general, hard IP blocks consume up to 90% less power than the equivalent soft logic implementations.

Incremental Compilation

The Intel Quartus Prime software incremental compilation feature reduces compilation time and helps preserve performance to ease timing closure. The incremental compilation feature enables the partial reconfiguration flow for Intel Arria 10 devices.

Incremental compilation supports top-down, bottom-up, and team-based design flows. This feature facilitates modular, hierarchical, and team-based design flows where different designers compile their respective design sections in parallel. Furthermore, different designers or IP providers can develop and optimize different blocks of the design independently. These blocks can then be imported into the top level project.

Document Revision History for Intel Arria 10 Device Overview

| Document Version | Changes |
|---------------------|--|
| 2018.04.09 | Updated the lowest V_{CC} from 0.83 V to 0.82 V in the topic listing a summary of the device features. |

| Date | Version | Changes |
|--------------|------------|--|
| January 2018 | 2018.01.17 | Updated the maximum data rate for HPS (Intel Arria 10 SX devices external memory interface DDR3 controller from 2,166 Mbps to 2,133 Mbps. |
| | | Updated maximum frequency supported for half rate QDRII and QDRII + SRAM to 633 MHz in Memory Standards Supported by the Soft Memory Controller table. |
| | | Updated transceiver backplane capability to 12.5 Gbps. |
| | | Removed transceiver speed grade 5 in Sample Ordering Core and Available Options for Intel Arria 10 GX Devices figure. |
| | · | continued |

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| July 2017 2017. July 2017 2017. May 2017 2017. March 2017 2017. October 2016 2016. May 2016 2016. | sion | Changes |
|--|--------|--|
| July 2017 2017. July 2017 2017. May 2017 2017. March 2017 2017. October 2016 2016. May 2016 2016. | | Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from Sample Ordering Core and Available Options for Intel Arria 10 GT Devices figure. Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps. Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from PMA Features of the Transceivers in Intel Arria 10 Devices table. |
| July 2017 2017. May 2017 2017. March 2017 2017. October 2016 2016. May 2016 2016. | .09.20 | Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps. |
| May 2017 2017. March 2017 2017. October 2016 2016. May 2016 2016. | .07.13 | Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C". |
| March 2017 2017. October 2016 2016. May 2016 2016. | 07.06 | Added automotive temperature option to Intel Arria 10 GX device family. |
| October 2016 2016. May 2016 2016. | .05.08 | Corrected protocol names with "1588" to "IEEE 1588v2". Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants. Removed all "Preliminary" marks. |
| May 2016 2016. | .03.15 | Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices. Rebranded as Intel. |
| , | .10.31 | Removed package F36 from Intel Arria 10 GX devices. Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers. |
| February 2016 2016. | 05.02 | Updated the FPGA Configuration and HPS Booting topic. Remove V _{CC} PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices. Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA. Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices. |
| | 02.11 | Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally. Revised the state for Core clock networks in the Summary of Features topic. Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table. Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table. Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table. Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure. Changed transceiver parameters in the "Low Power Serial Transceivers" section. Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table. Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure. Changed the datarates for GT devices in the "PMA Features" section. Changed the datarates for GT devices in the "PCS Features" section. |



| Date | Version | Changes |
|----------------|------------|---|
| December 2015 | 2015.12.14 | Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb. |
| | | Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources. |
| November 2015 | 2015.11.02 | • Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660. |
| | | Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in Number of Multipliers in Intel Arria 10 Devices table. |
| | | Updated the available options for Arria 10 GX, GT, and SX. Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>. |
| June 2015 | 2015.06.15 | Corrected label for Intel Arria 10 GT product lines in the vertical migration figure. |
| May 2015 | 2015.05.15 | Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller. |
| May 2015 | 2015.05.04 | Added support for 13.5G JESD204b in the Summary of Features table. Added support for 13.5G JESD204b in the Summary of Features table. |
| | | Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic. |
| | | Added a note to the table, Maximum Resource Counts for Arria 10 GT devices. |
| | | Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic. |
| January 2015 | 2015.01.23 | Added floating point arithmetic features in the Summary of Features table. |
| | | Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb. |
| | | Updated the table that lists the memory standards supported by Intel Arria 10 devices. |
| | | Removed support for DDR3U, LPDDR3 SDRAM, RLDRAM 2, and DDR2. Moved RLDRAM 3 support from hard memory controller to soft memory controller. RLDRAM 3 support uses hard PHY with soft memory controller. |
| | | Added soft memory controller support for QDR IV. |
| | | Updated the maximum resource count table to include the number of hard memory controllers available in each device variant. |
| | | Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps. |
| | | Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz. |
| | | Added a feature for fractional synthesis PLLs: PLL cascading. |
| | | Updated the HPS programmable general-purpose I/Os from 54 to 62. |
| September 2014 | 2014.09.30 | Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX. |
| | | Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660. |
| | | Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150. |
| | | continued |